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**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Pan et al.

**Serial No.:** 09/614,113

**Filed:** July 12, 2000

**For:** TECHNIQUE FOR ELIMINATION  
OF PITTING ON SILICON SUBSTRATE  
DURING GATE STACK ETCH

**Confirmation No.:** 1710

**Examiner:** C. Brown


**Group Art Unit:** 1765

**Attorney Docket No.:** 2915.3US  
(96-0149.2)

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

February 19, 2003  
Date

  
Signature

Amanda Holland  
Name (Type/Print)

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
Washington, D.C. 20231

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the document listed on attached Form PTO/SB/08 be considered by the Examiner and made of record. The listed document was cited by the Office in co-pending application Serial No. 09/073,494, filed May 6, 1998, and directed to a related invention. A copy of the listed document is enclosed pursuant to 37 C.F.R. § 1.98(a).

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as

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defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

U.S. Patent Documents

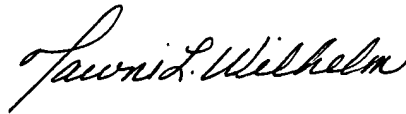
<u>U.S. Patent No.</u>	<u>Publication Date</u>	<u>Patentee</u>
US - 5,472,896	12/05/1995	Chen et al.

Applicants offer to supply any explanation or discussion of the document which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed after the filing a Brief on Appeal and after the mailing date of the first Office Action on the merits.

The fee pursuant to 37 C.F.R. § 1.17(p) is enclosed.

Respectfully submitted,



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TLW/ah

Enclosures: Form PTO/SB/08  
Copy of document cited  
Check No. 3799 in the amount of \$180.00

Document in ProLaw